

# EUROPEAN PATENT OFFICE

## Patent Abstracts of Japan

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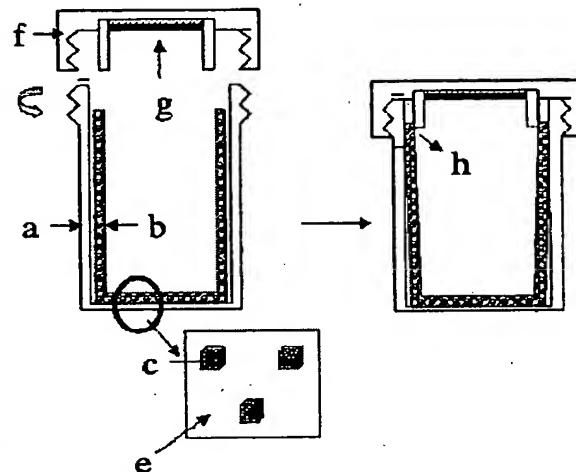
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TITLE : RESIN COMPOSITION COMPRISING  
INORGANIC COMPOUND AND  
LAMINATE AND PACKAGE USING THE  
SAME



ABSTRACT : PROBLEM TO BE SOLVED: To provide a resin composition comprising a hygroscopic inorganic compound having excellent moisture barrier properties, flexibility, elastic recovery and falling impact resistance and to provide a laminate and a package using the resin composition.

SOLUTION: The resin composition comprises 100 pts. wt. of a polymer consisting essentially of a polyolefin resin and 1-100 pts. wt. of at least the inorganic compound. In the resin composition, a polyolefinic resin (resin  $\alpha$ ) such as an ethylene- $\alpha$ -olefin copolymer or an ethylene-cyclic olefin copolymer obtained by using a single-site catalyst composed of a complex composed of groups III, IV, V, VI, IX and X transition metal atoms of the periodic table is contained in the polyolefin resin which is the principal component of the resin composition.

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